STARPOWER

SEMICONDUCTOR

FRED

FD200CCH60D3S

Molding Type Module

600V/200A in one-package

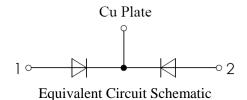


General Description

STARPOWER Diode Power Module provides low forward voltage as well as low reverse recovery loss. They are designed for the applications such as SMPS.

Features

- Fast soft diode
- Low forward voltage drop
- Small temperature coefficient
- Low reverse recovery losses
- High ruggedness
- Low inductance



Typical Applications

- SMPS
- PFC
- Electric welders
- DC choppers

Absolute Maximum Ratings T_C =25°C unless otherwise noted

Symbol	Description	FD200CCH60D3S	Units	
V_{RRM}	Repetitive Peak Reverse Voltage	600	V	
V_{RSM}	Non-repetitive Peak Reverse Voltage	600	V	
I_{FAV}	Average Forward Current T _C =100°C,Diode	100	A	
	$T_{C}=100^{\circ}\mathrm{C}$, Module	200		
I_{FSM}	Surge Forward Current V _R =0V,t _p =10ms,T _j =25°C	1600	A	
	$V_R=0V$, $t_p=8.3$ ms, $T_j=25$ °C	1760		
I^2 t	I^2 t-value $V_R=0V, t_p=10$ ms, $T_j=25$ °C	12800	A^2s	
	$V_{R}=0V,t_{p}=8.3ms,T_{j}=25^{\circ}C$	12907	AS	
$P_{\rm D}$	Maximum Power Dissipation @ T _j =150°C	579	W	
T_j	Junction Temperature	-40 to +150	$^{\circ}\mathbb{C}$	
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\mathbb{C}$	
M	Terminal Connection Torque, Screw M6	3.0 to 4.7	N.m	
	Mounting Torque, Screw M6	3.0 to 4.7		

Electrical Characteristics of Diode $T_C=25^{\circ}C$ unless otherwise noted

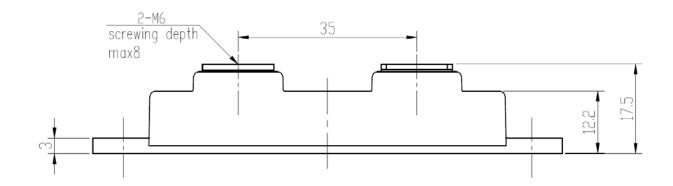
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
V_{F}	Diode Forward Voltage	I _F =100A	$T_j=25^{\circ}C$		1.35	1.55	V
			T _j =125℃		1.30	1.50	
I_R	$ \begin{array}{ c c c c } \hline \text{Diode Reverse} \\ \hline \text{Current} \\ \hline \end{array} V_R = V_R $	V -V	T _j =25℃			0.5	mA
		$\mathbf{v}_{\mathrm{R}} = \mathbf{v}_{\mathrm{RRM}}$	T _j =125 ℃			1.0	
t _{rr}	Reverse Recovery Time	T _j =25℃		78			
		* 4004	T _j =125 ℃		145		ns
I_{RM}	Peak Reverse Recovery Current I _F =100A V _R =300V	-	T _j =25℃		7.8		A
		$v_R=300 v$ $di/dt=-200 A/\mu s$	T _j =125℃		15.2		
Qr	Reverse Recovery Charge	α μο	T _j =25℃		402		nC
			T _j =125℃		1150		

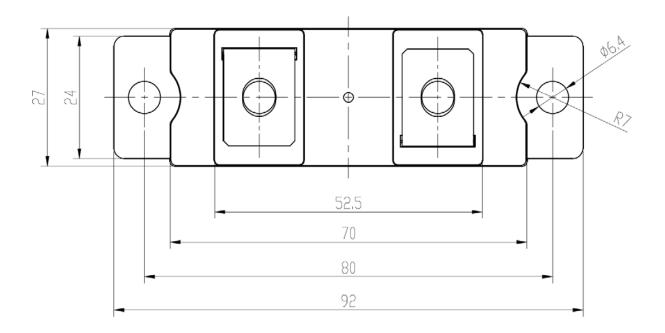
Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{ heta JC}$	Junction-to-Case		0.216	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.06		K/W
Weight	Weight of Module	95		g

Package Dimensions

Dimensions in Millimeters





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